

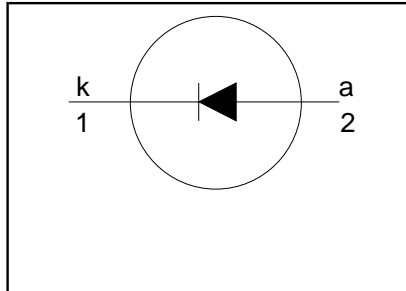
## Damper diode fast, high-voltage

## BY559X-1500U

### FEATURES

- Low forward volt drop
- Low forward recovery voltage
- Fast switching
- Soft recovery characteristic
- High thermal cycling performance
- Isolated mounting tab

### SYMBOL



### QUICK REFERENCE DATA

$$V_R = 1500 \text{ V}$$

$$V_F \leq 1.4 \text{ V}$$

$$V_{fr} \leq 10 \text{ V}$$

$$t_{rr} \leq 120 \text{ ns}$$

$$I_{F(\text{PEAK})} = 10 \text{ A}$$

$$I_{\text{FSM}} \leq 150 \text{ A}$$

### GENERAL DESCRIPTION

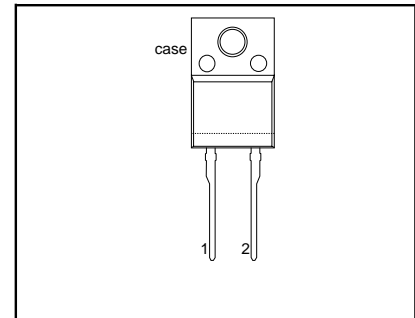
A double diffused rectifier diode in a plastic envelope, featuring fast forward and reverse recovery and low forward voltage. The device is intended for use as a damper diode in horizontal deflection circuits of large screen monitors and workstations.

The BY559X series is supplied in the conventional leaded SOD113 package.

### PINNING

PIN	DESCRIPTION
1	cathode
2	anode
tab	isolated

### SOD113



### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum System (IEC 134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$V_{RRM}$	Peak repetitive reverse voltage		-	1500	V
$V_{RWM}$	Crest working reverse voltage		-	1300	V
$I_{F(\text{PEAK})}$	Peak working forward current	$f = 130 \text{ kHz}$ ;	-	10	A
$I_{FRM}$	Peak repetitive forward current	$t = 100 \mu\text{s}$	-	150	A
$I_{FSM}$	Peak non repetitive forward current	$t = 10 \text{ ms}$ sinusoidal; $T_j = 150 \text{ }^\circ\text{C}$ prior to surge; with reapplied $V_{RWM(\text{max})}$	-	160	A
$T_{\text{stg}}$	Storage temperature		-40	150	$^\circ\text{C}$
$T_j$	Operating junction temperature		-	150	$^\circ\text{C}$

### ISOLATION LIMITING VALUE & CHARACTERISTIC

$T_{\text{hs}} = 25 \text{ }^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{\text{isol}}$	R.M.S. isolation voltage from both terminals to external heatsink	$f = 50\text{-}60 \text{ Hz}$ ; sinusoidal waveform; R.H. $\leq 65\%$ ; clean and dustfree	-		2500	V
$C_{\text{isol}}$	Capacitance from both terminals to external heatsink	$f = 1 \text{ MHz}$	-	10	-	pF

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### THERMAL RESISTANCES

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$R_{th\ j-hs}$	Thermal resistance junction to heatsink	with heatsink compound	-	-	3.6	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	in free air.	-	55	-	K/W

### STATIC CHARACTERISTICS

$T_j = 25\text{ °C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_F$	Forward voltage	$I_F = 6.5\text{ A}$	-	1.5	1.8	V
		$I_F = 6.5\text{ A}; T_j = 125\text{ °C}$	-	1.2	1.4	V
$I_R$	Reverse current	$V_R = V_{RWMmax}$	-	-	0.5	mA
		$V_R = V_{RWMmax}; T_j = 125\text{ °C}$	-	-	2.0	mA

### DYNAMIC CHARACTERISTICS

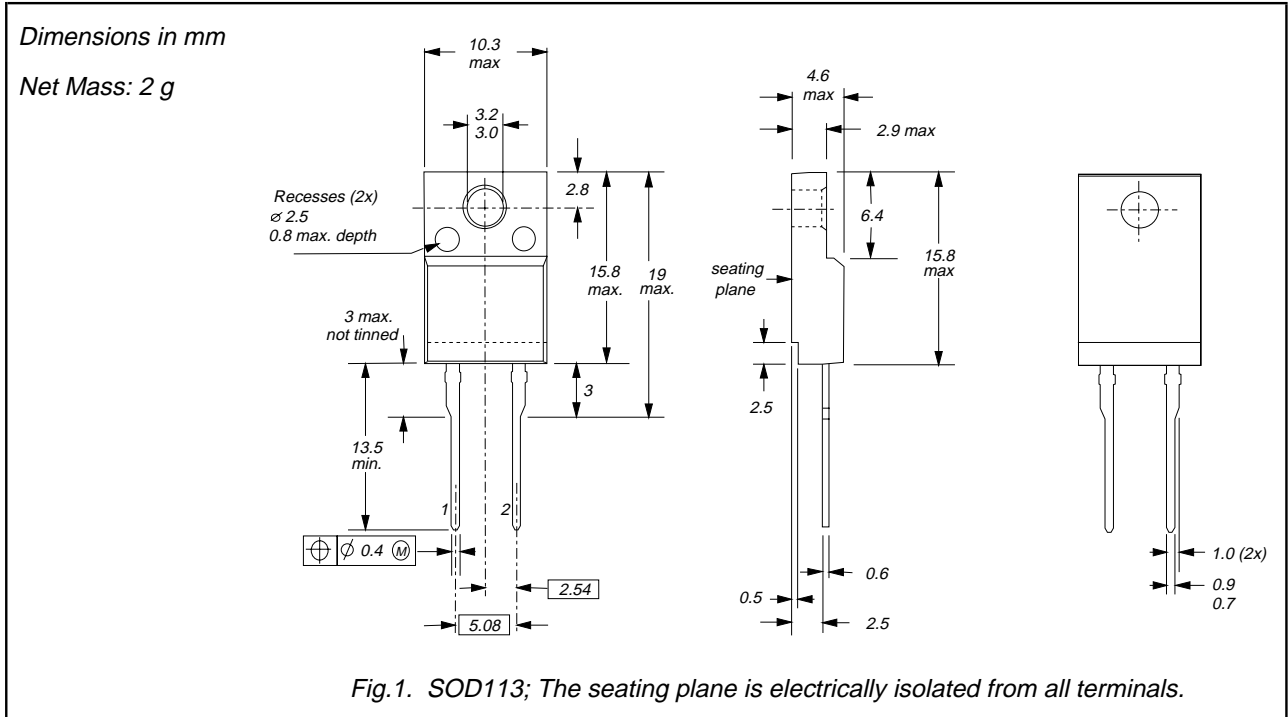
$T_j = 25\text{ °C}$  unless otherwise stated

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{fr}$	Forward recovery voltage	$I_F = 6.5$ ; $di_F/dt = 50\text{ A}/\mu\text{s}$	-	6	10	V
$t_{fr}$	Forward recovery time	$I_F = 6.5\text{ A}; di_F/dt = 50\text{ A}/\mu\text{s}; V_F = 5\text{ V}$	-	130	180	ns
$t_{rr}$	Reverse recovery time	$I_F = 1\text{ A}; -di_F/dt = 50\text{ A}/\mu\text{s}; V_R \geq 30\text{ V}$	-	90	120	ns
$Q_s$	Reverse recovery charge	$I_F = 2\text{ A}; -di_F/dt = 20\text{ A}/\mu\text{s}; V_R \geq 30\text{ V}$	-	0.2	0.25	$\mu\text{C}$

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**MECHANICAL DATA**



**Notes**

1. Refer to mounting instructions for F-pack envelopes.
2. Epoxy meets UL94 V0 at 1/8".

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## DEFINITIONS

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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